## **PRODUCT / PROCESS CHANGE NOTIFICATION**

1. PCN basic data		
1.1 Company STMicroelectronics International N.V		STMicroelectronics International N.V
1.2 PCN No.		MICROCONTROLLERS/24/14922
1.3 Title of PCN		JSCC (China) LQFP7x7 48L , LQFP10x10 64L and UFQFPN7X7 48L new BOM for STM32H523x and STM32H533x listed product.
1.4 Product Category		STM32H523xx & STM32H533xx
1.5 Issue date		2024-08-18

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	PIKE EMMA	
2.1.2 Phone	+44 1628896111	
2.1.3 Email	emma.pike@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Ricardo Antonio DE SA EARP	
2.1.2 Marketing Manager	Veronique BARLATIER	
2.1.3 Quality Manager	Pascal NARCHE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Direct Material: Bond Wire - Metallurgy (metallic composition/ raw material)	StatsChipPAC JSCC Jiangyin China

4. Description of change		
	Old	New
4.1 Description	- JSCC (Ćhina) / Gold wire	Assembly lines / wire bonding: - JSCC (China) / Copper Palladium wire additional source - JSCC (China) / Gold wire
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No change in Form, no change in Fit, no change in Function. Package darkness might change depending on molding compound. Pin1 identifier remain in the same corner but might slightly change in terms of form and positioning.	

5. Reason / motivation for change		
	Due to the success on the market of STM32 devices, ST Microcontrollers Division decided to qualify an additional back-end assembly line to maintain state of the art service level to our customers thanks to extra capacity.	
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change	
6.1 Description	Traceability ensure by ST internal tools

7. Timing / schedule		
7.1 Date of qualification results	2024-08-05	
7.2 Intended start of delivery	2024-11-01	
7.3 Qualification sample available? Upon Request		

8. Qualification / Validation			
8.1 Description 14922 PCN14922_Reliability RER2220 and RER2321.pdf			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2024-08-18

## 9. Attachments (additional documentations)

14922 Public product.pdf 14922 PCN14922\_Reliability RER2220 and RER2321.pdf 14922 PCN14922\_Additional information.pdf

	10. Affected parts			
	10. 1 Current	10.2 New (if applicable)		
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No		
	STM32H523CET6			
	STM32H523CEU6			
	STM32H523RCT6			
	STM32H523RET6			
	STM32H533CET6			
	STM32H533CEU6			
	STM32H533RET6			
	STM32H523CCT6			
	STM32H523CCU6			
	STM32H523RCT7			

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